imall

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Glass Passivated High Efficient Rectifiers

FEATURES

- Glass passivated chip junction
- Excellent high temperature switching
- Idally suited for use in very high frequency switching power supplies, inverters and as free wheeling diodes
- Ultrafast recovery time for high efficiency
- Soft recovery characteristics
- Compliant to RoHS Directive 2011/65/EU and in accordance to WEEE 2002/96/EC
- Halogen-free according to IEC 61249-2-21 definition



DO-204AL (DO-41)

MECHANICAL DATA

Case: DO-204AL (DO-41)

Molding compound, UL flammability classification rating 94V-0 Base P/N with suffix "G" on packing code - green compound (halogen-free) Base P/N with prefix "H" on packing code - AEC-Q101 qualified **Terminal:** Matte tin plated leads, solderable per JESD22-B102 Meet JESD 201 class 1A whisker test, with prefix "H" on packing code meet JESD 201 class 2 whisker test **Weight:** 0.33g (approximately)

MAXIMUM RATINGS AND ELECTRICAL CHARACTERSTICS (T _A =25°C unless otherwise noted)									
PARAMETER	SYMBOL	UF1A	UF1B	UF1D	UF1G	UF1J	UF1K	UF1M	UNIT
Maximum repetitive peak reverse voltage	V _{RRM}	50	100	200	400	600	800	1000	V
Maximum RMS voltage	V _{RMS}	35	70	140	280	420	560	700	V
Maximum DC blocking voltage	V _{DC}	50	100	200	400	600	800	1000	V
Maximum average forward rectified current	I _{F(AV)}	1					А		
Peak forward surge current, 8.3 ms single half sine-wave superimposed on rated load	I _{FSM}	30					А		
Maximum instantaneous forward voltage (Note 1) @ 1 A	V _F	1.0 1.7				V			
Maximum reverse current @ rated VR T_J =25 $^{\circ}C$ T_J =125 $^{\circ}C$	I _R	5 150				μA			
Maximum reverse recovery time (Note 2)	Trr	50 75			ns				
Typical junction capacitance (Note 3)	Cj	17				pF			
Typical thermal resistance	R _{θJL} R _{θJA}	15 60				^o C/W			
Operating junction temperature range	TJ	- 55 to +150				оС			
Storage temperature range	T _{STG}	- 55 to +150				°C			

Note 1: Pulse test with PW=300µs, 1% duty cycle

Note 2: Reverse Recovery Test Conditions: I_F =0.5A, I_R =1.0A, I_{RR} =0.25A

Note 3: Measured at 1 MHz and Applied Reverse Voltage of 4.0V D.C.



UF1A thru UF1M

Taiwan Semiconductor

ORDERING INFORMATION

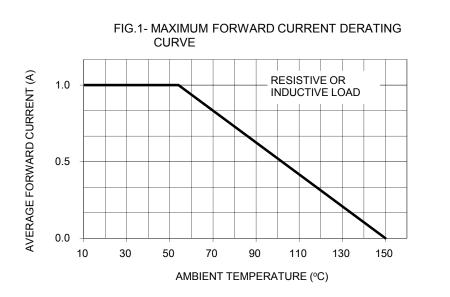
PART NO.	AEC-Q101	PACKING CODE	GREEN COMPOUND	PACKAGE	PACKING	
	QUALIFIED		CODE			
UF1x Prefix "H" (Note 1)		A0		DO-41	3,000 / Ammo box (52mm taping	
	R0	Suffix "G"	DO-41	5,000 / 13" Paper reel		
		R1	Sullix G	DO-41	5,000 / 13" Paper reel (Reverse)	
		B0		DO-41	1,000 / Bulk packing	

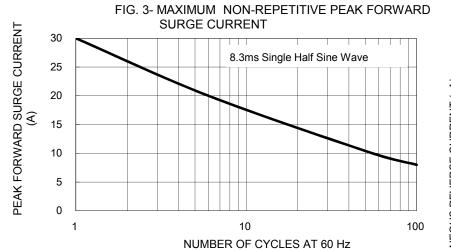
Note 1: "x" defines voltage from 50V (UF1A) to 1000V (UF1M)

EXAMPLE						
PREFERRED P/N	PART NO.	AEC-Q101 QUALIFIED	PACKING CODE	GREEN COMPOUND CODE	DESCRIPTION	
UF1M A0	UF1M		A0			
UF1M A0G	UF1M		A0	G	Green compound	
UF1MHA0	UF1M	Н	A0		AEC-Q101 qualified	

RATINGS AND CHARACTERISTICS CURVES

(TA=25 $^{\circ}$ C unless otherwise noted)

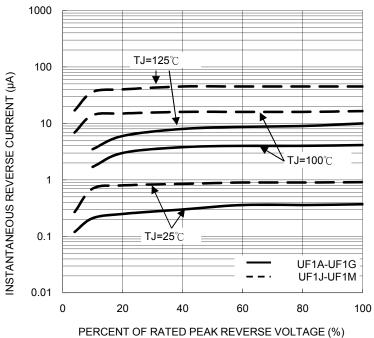




10 UF1A-UF1G 1 UF1A-UF1G UF1A-UF1G UF1A-UF1G UF1A-UF1G UF1J-UF1M UF1J-UF1M UF1J-UF1M 0.1 0.4 0.6 0.8 1.0 1.2 1.4 1.6 1.8 2.0

FIG. 2- TYPICAL FORWARD CHARACTERISTICS

FIG. 4- TYPICAL REVERSE CHARACTERISTICS





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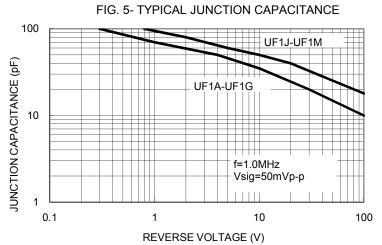
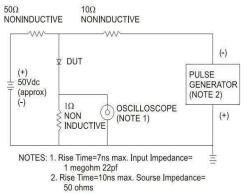
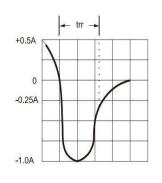
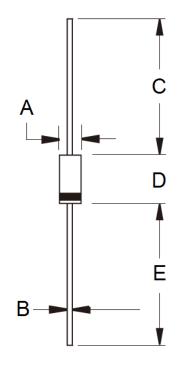


FIG.6- REVERSE RECOVERY TIME CHARACTERISTIC AND TEST CIRCUIT DIAGRAM





PACKAGE OUTLINE DIMENSIONS



DIM.	Unit	(mm)	Unit (inch)			
	Min	Max	Min	Max		
А	2.00	2.70	0.079	0.106		
В	0.71	0.86	0.028	0.034		
С	25.40	-	1.000	-		
D	4.20	5.20	0.165	0.205		
E	25.40	-	1.000	-		

MARKING DIAGRAM



P/N =Specific Device CodeG =Green CompoundYWW =Date Code

Factory Code

F =



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